

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

General Purpose & High Capacitance

Class 2, X7R

6.3 V TO 50 V

100 pF to 22 μ F

RoHS compliant & Halogen Free



SCOPE

This specification describes X7R series chip capacitors with lead-free terminations.

APPLICATIONS

- PCs, Hard disk, Game PCs
- DVDs, Video cameras
- Mobile phones
- Data processing

FEATURES

- Supplied in tape on reel
- Nickel-barrier end termination
- RoHS compliant
- Halogen Free compliant

ORDERING INFORMATION - GLOBAL PART NUMBER, PHYCOMP**CTC & I2NC**

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

YAGEO BRAND ordering code**GLOBAL PART NUMBER (PREFERRED)**

CC xxxx x x **X7R** x **BB** xxx
 (1) (2) (3) (4) (5)

(1) SIZE – INCH BASED (METRIC)

0201 (0603)
 0402 (1005)
 0603 (1608)
 0805 (2012)
 1206 (3216)
 1210 (3225)
 1812 (4532)

(2) TOLERANCE

J = $\pm 5\%$ ⁽¹⁾
 K = $\pm 10\%$
 M = $\pm 20\%$

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch
 K = Blister taping reel; Reel 7 inch
 P = Paper/PE taping reel; Reel 13 inch
 F = Blister taping reel; Reel 13 inch

(4) RATED VOLTAGE

5 = 6.3 V
 6 = 10 V
 7 = 16 V
 8 = 25 V
 9 = 50 V

(5) CAPACITANCE VALUE

2 significant digits+number of zeros
 The 3rd digit signifies the multiplying factor, and letter R is decimal point
 Example: 103 = $10 \times 10^3 = 10,000 \text{ pF} = 10 \text{ nF}$

NOTE

1. Tolerance $\pm 5\%$ is not available for full product range, please contact local sales force before ordering

CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.

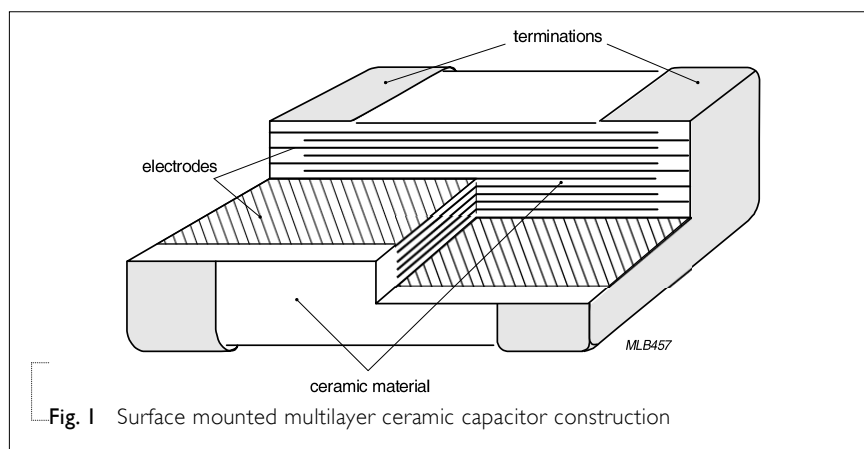


Fig. 1 Surface mounted multilayer ceramic capacitor construction

DIMENSION

Table I For outlines see fig. 2

TYPE	L ₁ (mm)	W (mm)	T (MM)	L ₂ / L ₃ (mm)		L ₄ (mm)	DIMENSION CODE
				min.	Max.	min.	
0201	0.6 ±0.03	0.3 ±0.03	0.3 ±0.03	0.1	0.2	0.2	BA
0402	1.0 ±0.05	0.5 ±0.05	0.5 ±0.05	0.15	0.35	0.4	CA
0603	1.6 ±0.1	0.8 ±0.1	0.8 ±0.1	0.2	0.6	0.4	DA
	1.6 ±0.15	0.8 ±0.15	0.8 ±0.15	0.2	0.6	0.4	DB
	1.6 ±0.2	0.8 ±0.2	0.8 ±0.2	0.2	0.6	0.4	DC
0805	2.0 ±0.1	1.25 ±0.1	0.6 ±0.1	0.25	0.75	0.55	E0
	2.0 ±0.1	1.25 ±0.1	0.85 ±0.1	0.25	0.75	0.55	EA
	2.0 ±0.2	1.25 ±0.2	1.25 ±0.2	0.25	0.75	0.55	EB
1206	3.2 ±0.15	1.6 ±0.15	0.85 ±0.1	0.25	0.75	1.4	F0
	3.2 ±0.2	1.6 ±0.2	1.0 ±0.1	0.25	0.75	1.4	F1
	3.2 ±0.2	1.6 ±0.2	1.15 ±0.1	0.25	0.75	1.4	FA
	3.2 ±0.3	1.6 ±0.2	1.6 ±0.2	0.25	0.8	1.4	FC
	3.2 ±0.3	1.6 ±0.3	1.6 ±0.3	0.3	0.9	1.4	FD
1210	3.2 ±0.2	2.5 ±0.2	0.85 ±0.1	0.25	0.75	1.4	G0
	3.2 ±0.4	2.5 ±0.3	1.15 ±0.1	0.25	0.75	1.4	G1
	3.2 ±0.4	2.5 ±0.3	1.25 ±0.2	0.25	0.75	1.4	GA
	3.2 ±0.4	2.5 ±0.3	1.6 ±0.2	0.25	0.75	1.4	G2
	3.2 ±0.4	2.5 ±0.3	1.9 ±0.2	0.25	0.75	1.4	GB
	3.2 ±0.4	2.5 ±0.3	2.5 ±0.2	0.25	0.75	1.0	GC
	3.2 ±0.4	2.5 ±0.3	2.5 ±0.3	0.25	0.75	1.0	GD
	4.5 ±0.2	3.2 ±0.2	0.85 ±0.1	0.25	0.75	2.2	JA
1812	4.5 ±0.2	3.2 ±0.2	1.15 ±0.1	0.25	0.75	2.2	JB
	4.5 ±0.4	3.2 ±0.4	1.6 ±0.2	0.25	0.75	2.2	JC

OUTLINES

For dimension see Table I

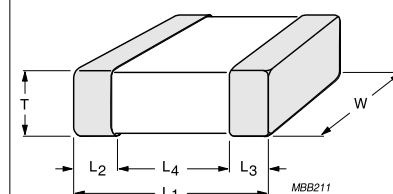


Fig. 2 Surface mounted multilayer ceramic capacitor dimension

CAPACITANCE RANGE & THICKNESS FOR X7R**Table 2** Sizes from 0201 to 0402

CAP.	0201					0402				
	6.3 V	10 V	16 V	25 V	50 V	6.3 V	10 V	16 V	25 V	50 V
100 pF	BA	BA	BA	BA	BA	CA	CA	CA	CA	CA
150 pF	BA	BA	BA	BA	BA	CA	CA	CA	CA	CA
220 pF	BA	BA	BA	BA	BA	CA	CA	CA	CA	CA
330 pF	BA	BA	BA	BA	BA	CA	CA	CA	CA	CA
470 pF	BA	BA	BA	BA	BA	CA	CA	CA	CA	CA
680 pF	BA	BA	BA	BA	BA	CA	CA	CA	CA	CA
1.0 nF	BA	BA	BA	BA	BA	CA	CA	CA	CA	CA
1.5 nF	BA	BA	BA	BA		CA	CA	CA	CA	CA
2.2 nF	BA	BA	BA	BA		CA	CA	CA	CA	CA
3.3 nF	BA	BA	BA	BA		CA	CA	CA	CA	CA
4.7 nF	BA	BA	BA	BA		CA	CA	CA	CA	CA
6.8 nF	BA	BA	BA	BA		CA	CA	CA	CA	CA
10 nF	BA	BA	BA	BA		CA	CA	CA	CA	CA
15 nF						CA	CA	CA	CA	CA
22 nF						CA	CA	CA	CA	CA
33 nF						CA	CA	CA	CA	CA
47 nF						CA	CA	CA	CA	CA
68 nF						CA	CA	CA	CA	
100 nF	BA					CA	CA	CA	CA	CA
150 nF										
220 nF						CA	CA	CA		
330 nF										
470 nF						CA	CA			
680 nF										
1.0 μ F						CA				
2.2 μ F										
4.7 μ F										
10 μ F										
22 μ F										

NOTE

1. Values in shaded cells indicate thickness class in mm
2. Capacitance value of non E-6 series is on request
3. For product with 5% tolerance, please contact local sales force before ordering

CAPACITANCE RANGE & THICKNESS FOR X7R**Table 3** Sizes from 0603 to 0805

CAP.	0603					0805				
	6.3 V	10 V	16 V	25 V	50 V	6.3 V	10 V	16 V	25 V	50 V
100 pF	DA	DA	DA	DA	DA					
150 pF	DA	DA	DA	DA	DA					
220 pF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
330 pF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
470 pF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
680 pF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
1.0 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
1.5 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
2.2 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
3.3 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
4.7 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
6.8 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
10 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
15 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
22 nF	DA	DA	DA	DA	DA	E0	E0	E0	E0	E0
33 nF	DA	DA	DA	DA	DA	EA	EA	EA	EA	EA
47 nF	DA	DA	DA	DA	DA	EA	EA	EA	EA	EA
68 nF	DA	DA	DA	DA	DA	EA	EA	EA	EA	EA
100 nF	DA	DA	DA	DA	DA	EA	EA	EA	EA	EA
150 nF	DA	DA	DA	DA	DA	EA	EA	EA	EA	EA
220 nF	DA	DA	DA	DA	DA	EA	EA	EA	EA	EB
330 nF	DA	DA	DA	DA		EB	EB	EB	EB	EB
470 nF	DA	DA	DA	DA	DA	EB	EB	EB	EB	EB
680 nF	DA	DA	DA	DA		EB	EB	EB	EB	EB
1.0 μ F	DA	DA	DA	DA	DB	EB	EB	EB	EB	EB
2.2 μ F	DA	DA	DC			EB	EB	EB	EB	EB
4.7 μ F	DC					EB	EB	EB	EB	
10 μ F						EB	EB	EB		
22 μ F										

NOTE

1. Values in shaded cells indicate thickness class in mm
2. Capacitance value of non E-6 series is on request
3. For product with 5% tolerance, please contact local sales force before ordering

CAPACITANCE RANGE & THICKNESS FOR X7R**Table 4** Size 1206

CAP.	1206				
	6.3 V	10 V	16 V	25 V	50 V
100 pF					
150 pF					
220 pF	F0	F0	F0	F0	F0
330 pF	F0	F0	F0	F0	F0
470 pF	F0	F0	F0	F0	F0
680 pF	F0	F0	F0	F0	F0
1.0 nF	F0	F0	F0	F0	F0
1.5 nF	F0	F0	F0	F0	F0
2.2 nF	F0	F0	F0	F0	F0
3.3 nF	F0	F0	F0	F0	F0
4.7 nF	F0	F0	F0	F0	F0
6.8 nF	F0	F0	F0	F0	F0
10 nF	F0	F0	F0	F0	F0
15 nF	F0	F0	F0	F0	F0
22 nF	F0	F0	F0	F0	F0
33 nF	F0	F0	F0	F0	F0
47 nF	F0	F0	F0	F0	F0
68 nF	F0	F0	F0	F0	F0
100 nF	F0	F0	F0	F0	F0
150 nF	F0	F0	F0	F0	FA
220 nF	F0	F0	F0	F0	FA
330 nF	F0	F0	F0	F0	F0
470 nF	F0	F0	F0	F0	FI
680 nF	FA	FA	FA	FA	FC
1.0 μ F	FA	FA	FA	FA	FC
2.2 μ F	FA	FA	FA	FA	FC
4.7 μ F	FC	FC	FC	FC	FC
10 μ F	FC	FC	FC	FC	
22 μ F	FC	FC	FD		
47 μ F					

NOTE

1. Values in shaded cells indicate thickness class in mm
2. Capacitance value of non E-6 series is on request
3. For product with 5% tolerance, please contact local sales force before ordering
4. Please contact local sales force for special ordering code before ordering

CAPACITANCE RANGE & THICKNESS FOR X7R**Table 5** Sizes from 1210 to 1812

CAP.	1210					1812
	6.3 V	10 V	16 V	25 V	50 V	50 V
100 pF						
150 pF						
220 pF						
330 pF						
470 pF						
680 pF						
1.0 nF						
1.5 nF						
2.2 nF	G0	G0	G0	G0	G0	
3.3 nF	G0	G0	G0	G0	G0	
4.7 nF	G0	G0	G0	G0	G0	JA
6.8 nF	G0	G0	G0	G0	G0	JA
10 nF	G0	G0	G0	G0	G0	JA
15 nF	G0	G0	G0	G0	G0	JA
22 nF	G0	G0	G0	G0	G0	JA
33 nF	G0	G0	G0	G0	G0	JA
47 nF	G0	G0	G0	G0	G0	JA
68 nF	G0	G0	G0	G0	G0	JA
100 nF	G0	G0	G0	G0	G0	JB
150 nF	G0	G0	G0	G0	G1	JB
220 nF	G0	G0	G0	G0	G1	JB
330 nF	G0	G0	G0	G0	G1	JB
470 nF	G1	G1	G1	G1	GA	JB
680 nF	G1	G1	G1	G1	GA	JC
1.0 µF	GA	GA	GA	GA	GA	JC
2.2 µF	GB	GB	GB	GB	GB	
4.7 µF	GB	GB	GB	GB	GD	
10 µF	GB	GB	GB	GB		
22 µF	GC	GC	GC	GC		
47 µF	GC	GC				

NOTE

1. Values in shaded cells indicate thickness class in mm
2. Capacitance value of non E-6 series is on request
3. For product with 5% tolerance, please contact local sales force before ordering
4. Please contact local sales force for special ordering code before ordering

THICKNESS CLASSES AND PACKING QUANTITY

Table 6

SIZE CODE	THICKNESS CLASSIFICATION	TAPE WIDTH QUANTITY PER REEL	Ø180 MM / 7 INCH		Ø330 MM / 13 INCH		QUANTITY PER BULK CASE
			Paper	Blister	Paper	Blister	
0201	0.3 ±0.03 mm	8 mm	15,000	---	50,000	---	---
0402	0.5 ±0.05 mm	8 mm	10,000	---	50,000	---	50,000
0603	0.8 ±0.1 mm	8 mm	4,000	---	15,000	---	15,000
0805	0.6 ±0.1 mm	8 mm	4,000	---	20,000	---	10,000
	0.85 ±0.1 mm	8 mm	4,000	---	15,000	---	8,000
	1.25 ±0.2 mm	8 mm	---	3,000	---	10,000	5,000
1206	0.6 ±0.1 mm	8 mm	4,000	---	20,000	---	---
	0.85 ±0.1 mm	8 mm	4,000	---	15,000	---	---
	1.00 / 1.15 ±0.1 mm	8 mm	---	3,000	---	10,000	---
	1.25 ±0.2 mm	8 mm	---	3,000	---	10,000	---
	1.6 ±0.15 mm	8 mm	---	2,500	---	10,000	---
	1.6 ±0.2 mm	8 mm	---	2,000	---	8,000	---
1210	0.6 / 0.7 ±0.1 mm	8 mm	---	4,000	---	15,000	---
	0.85 ±0.1 mm	8 mm	---	4,000	---	10,000	---
	1.15 ±0.1 mm	8 mm	---	3,000	---	10,000	---
	1.15 ±0.15 mm	8 mm	---	3,000	---	10,000	---
	1.25 ±0.2 mm	8 mm	---	3,000	---	---	---
	1.5 ±0.1 mm	8 mm	---	2,000	---	---	---
	1.6 / 1.9 ±0.2 mm	8 mm	---	2,000	---	---	---
	2.0 ±0.2 mm	8 mm	---	2,000 1,000	---	---	---
1808	2.5 ±0.2 mm	8 mm	---	1,000 500	---	---	---
	1.15 ±0.15 mm	12 mm	---	3,000	---	---	---
	1.25 ±0.2 mm	12 mm	---	3,000	---	---	---
	1.35 ±0.15 mm	12 mm	---	2,000	---	---	---
	1.5 ±0.1 mm	12 mm	---	2,000	---	---	---
	1.6 ±0.2 mm	12 mm	---	2,000	---	8,000	---
1812	2.0 ±0.2 mm	12 mm	---	2,000	---	---	---
	0.6 / 0.85 ±0.1 mm	12 mm	---	2,000	---	---	---
	1.15 ±0.1 mm	12 mm	---	1,000	---	---	---
	1.25 ±0.2 mm	12 mm	---	1,000	---	---	---
	1.5 ±0.1 mm	12 mm	---	1,000	---	---	---
	1.6 ±0.2 mm	12 mm	---	1,000	---	---	---
	2.0 ±0.2 mm	12 mm	---	1,000	---	---	---
	2.5 ±0.2 mm	12 mm	---	500	---	---	---

ELECTRICAL CHARACTERISTICS**X7R DIELECTRIC CAPACITORS; NISN TERMINATIONS**

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 7

DESCRIPTION							VALUE
Capacitance range							100 pF to 47 μ F
Capacitance tolerance							$\pm 5\%$, $\pm 10\%$, $\pm 20\%$
Dissipation factor (D.F.)							
X7R	0201	0402	0603	0805	1206	1210	
$\leq 10V$	100pF to 10nF	100pF to 100nF	100pF to 1 μ F	150pF to 2.2 μ F	220pF to 2.2 μ F	2.2nF to 2.2 μ F	$\leq 5\%$
	100nF	220nF to 470nF	2.2 μ F to 4.7 μ F	4.7 μ F to 10 μ F	4.7 μ F to 22 μ F	4.7 μ F to 47 μ F	$\leq 10\%$
		1 μ F					$\leq 12.5\%$
16V	100pF to 1.2nF	100pF to 22nF	100pF to 220nF	150pF to 470nF	220pF to 1 μ F	2.2nF to 1 μ F	$\leq 3.5\%$
	1.5nF to 10nF	27nF to 100nF	470nF to 1.0 μ F	680 nF to 2.2 μ F	2.2 μ F	2.2 μ F to 10 μ F	$\leq 5\%$
		220nF	2.2 μ F	4.7 μ F to 10 μ F	4.7 μ F to 22 μ F	22 μ F	$\leq 10\%$
25V	100pF to 470pF	100pF to 10nF	100pF to 39nF	150pF to 180nF	220pF to 680nF	2.2nF to 1 μ F	$\leq 2.5\%$
		12 nF to 47nF	47nF to 220nF	220nF to 470nF	1 μ F		$\leq 3.5\%$
	560pF to 10nF	56nF to 100nF		680nF to 1 μ F	2.2 μ F	2.2 μ F	$\leq 5\%$
50V			270nF to 1 μ F	2.2 μ F to 4.7 μ F	4.7 μ F to 22 μ F	4.7 μ F to 22 μ F	$\leq 10\%$
	100pF to 1nF	100pF to 10nF	100pF to 39nF	150pF to 180nF	220pF to 470nF	2.2nF to 1 μ F	$\leq 2.5\%$
		12 nF to 47nF	47nF to 220nF	220nF to 470nF	680nF to 1 μ F		$\leq 3.5\%$
				680nF			$\leq 5\%$
		100nF	470nF to 1 μ F	1 μ F to 2.2 μ F	2.2 μ F to 4.7 μ F	2.2 μ F to 10 μ F	$\leq 10\%$
Insulation resistance after 1 minute at U_r (DC)				$R_{ins} \geq 10 G\Omega$ or $R_{ins} \times C_r \geq 500(100)^*$ seconds whichever is less			
Maximum capacitance change as a function of temperature (temperature characteristic/coefficient):							$\pm 15\%$
Operating temperature range:							-55°C to $+125^\circ\text{C}$

NOTE

* For individual I.R specification, please contact local sales.

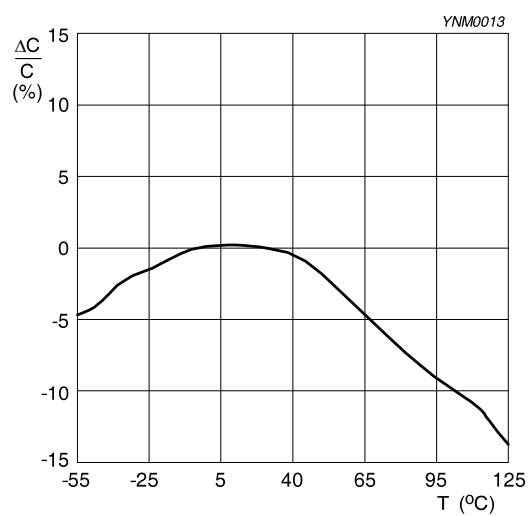


Fig. 3 Typical capacitance change as a function of temperature

Size 0201 10 nF / 16 V
Solid lines: Impedance / Dotted lines: ESR

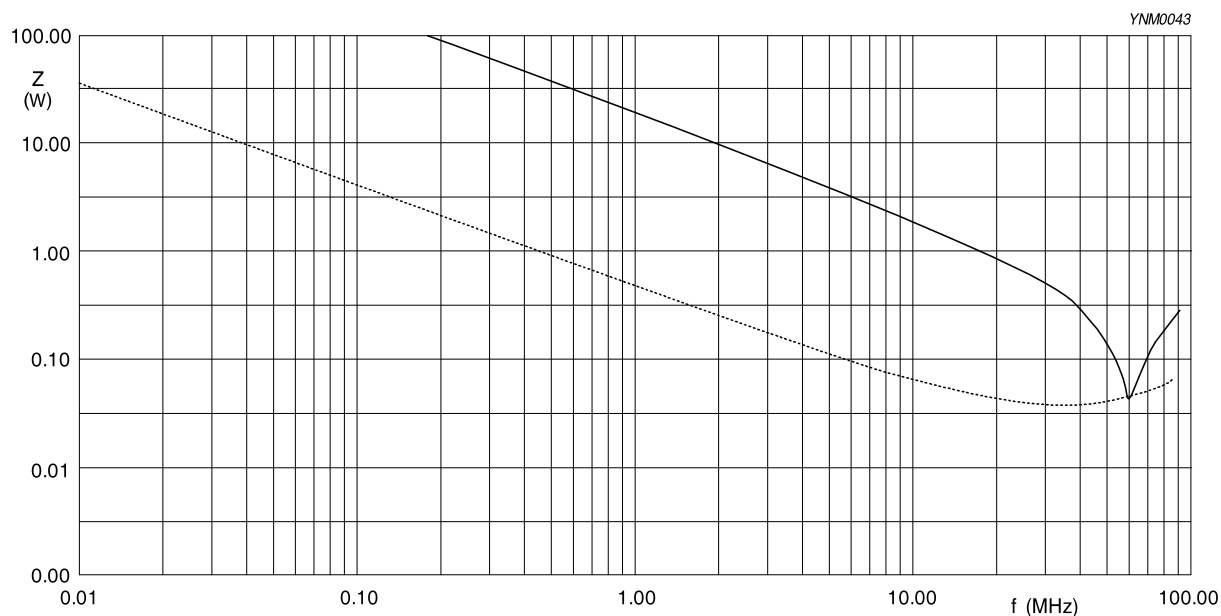


Fig. 4 Impedance ESR vs. frequency characteristics for multilayer chip capacitors

Size 0402 100 nF / 16 V
Solid lines: Impedance / Dotted lines: ESR

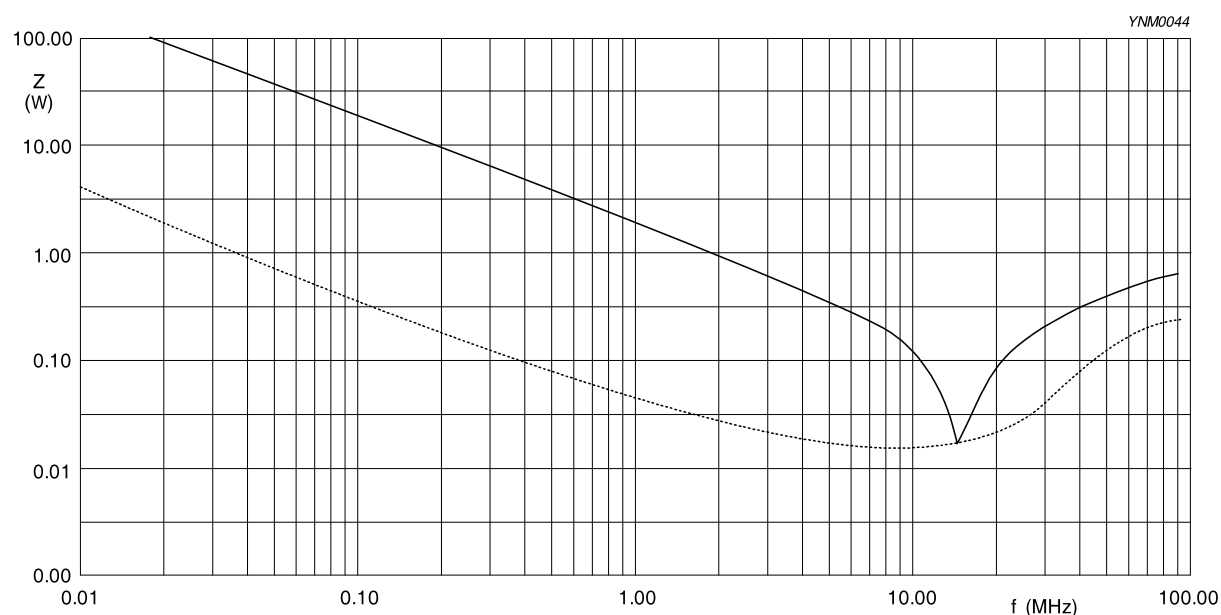


Fig. 5 Impedance ESR vs. frequency characteristics for multilayer chip capacitors

Size 0603 1 μF / 16 V
Solid lines: Impedance / Dotted lines: ESR

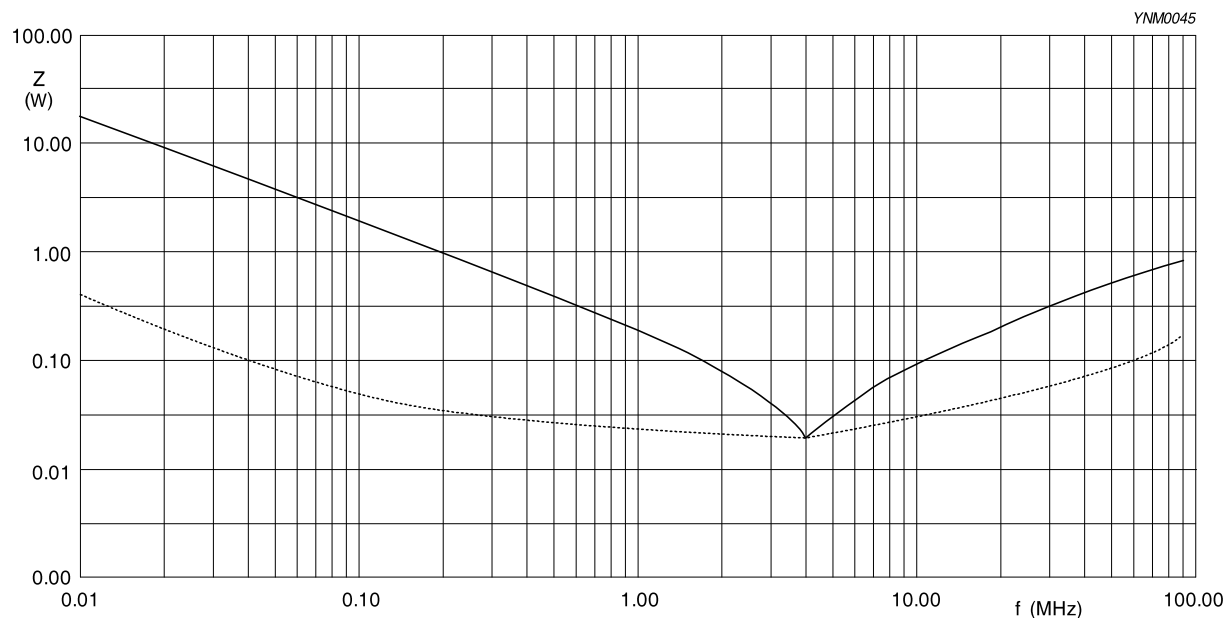


Fig. 6 Impedance ESR vs. frequency characteristics for multilayer chip capacitors

Size 0805 1 μF / 16 V
Solid lines: Impedance / Dotted lines: ESR

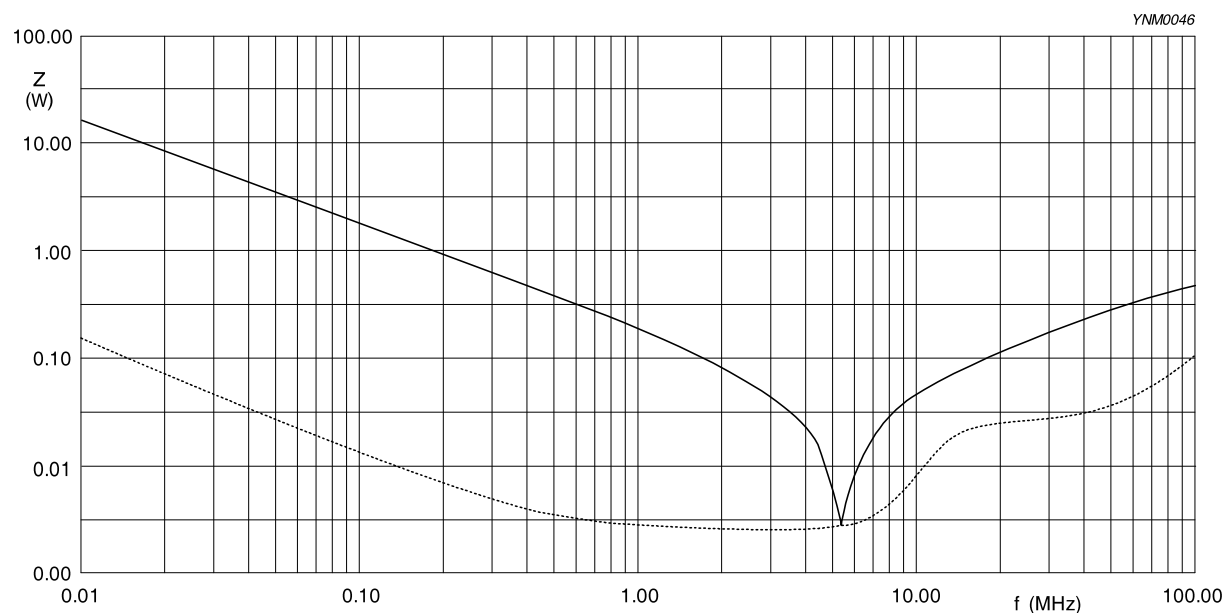


Fig. 7 Impedance ESR vs. frequency characteristics for multilayer chip capacitors

Size 1206 1 μ F / 25 V
Solid lines: Impedance / Dotted lines: ESR

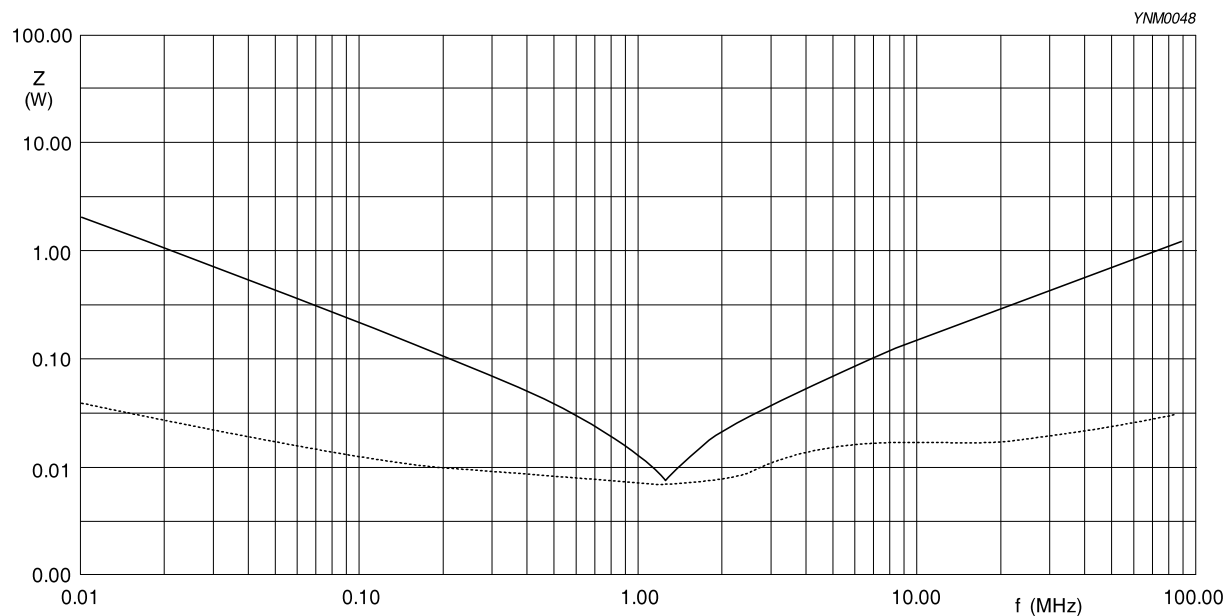


Fig. 8 Impedance ESR vs. frequency characteristics for multilayer chip capacitors

Size 1206 10 μ F / 10 V
Solid lines: Impedance / Dotted lines: ESR

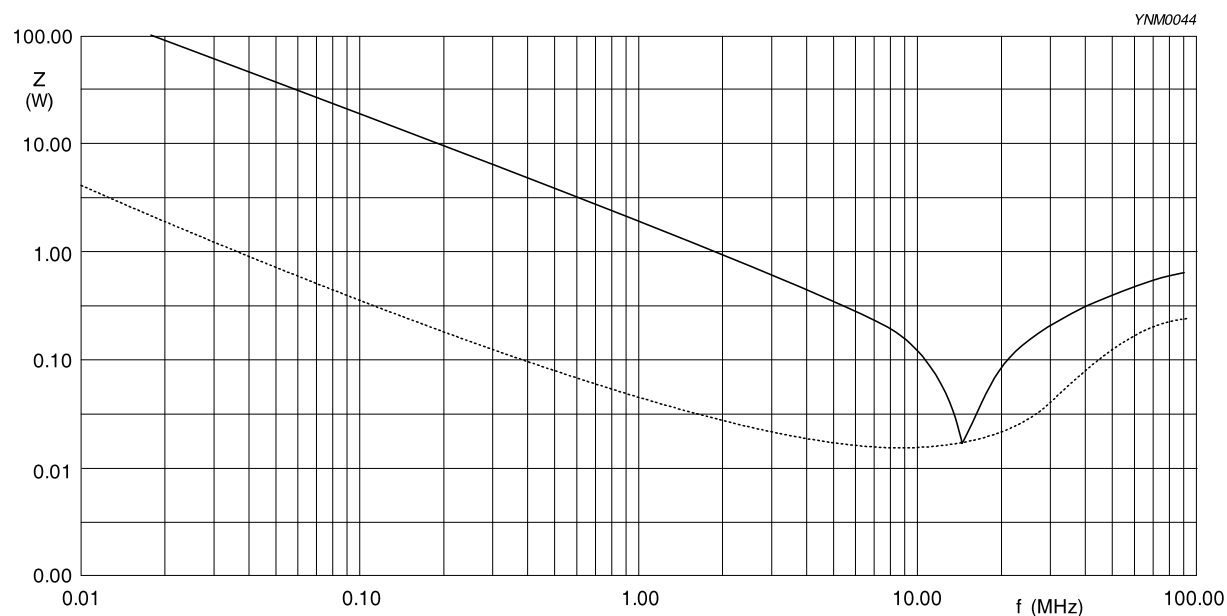


Fig. 9 Impedance ESR vs. frequency characteristics for multilayer chip capacitors

SOLDERING RECOMMENDATION

Table 8

SOLDERING METHOD	SIZE 0201	0402	0603	0805	1206	≥ 1210
Reflow	Reflow only	> 100 nF	> 1 μ F	> 2.2 μ F	> 4.7 μ F	Reflow only
Reflow/Wave		≤ 100 nF	≤ 1 μ F	≤ 2.2 μ F	≤ 4.7 μ F	---

TESTS AND REQUIREMENTS

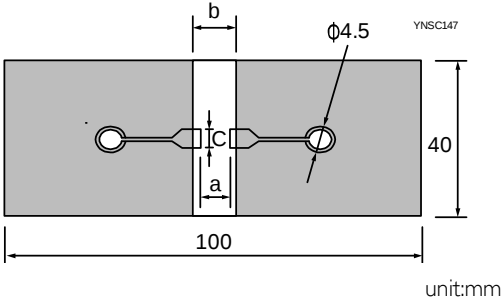
Table 9 Test procedures and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384-21/22 4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual Inspection and Dimension Check	4.4	Any applicable method using $\times 10$ magnification	In accordance with specification
Capacitance ⁽¹⁾	4.5.1	Class 2: At 20 °C, 24 hrs after annealing $f = 1$ KHz for $C \leq 10 \mu\text{F}$, rated voltage > 6.3 V, measuring at voltage $1 V_{\text{rms}}$ at 20 °C $f = 1$ KHz, for $C \leq 10 \mu\text{F}$, rated voltage ≤ 6.3 V, measuring at voltage $0.5 V_{\text{rms}}$ at 20 °C $f = 120$ Hz for $C > 10 \mu\text{F}$, measuring at voltage $0.5 V_{\text{rms}}$ at 20 °C	Within specified tolerance
Dissipation Factor (D.F.) ⁽¹⁾	4.5.2	Class 2: At 20 °C, 24 hrs after annealing $f = 1$ KHz for $C \leq 10 \mu\text{F}$, rated voltage > 6.3 V, measuring at voltage $1 V_{\text{rms}}$ at 20 °C $f = 1$ KHz, for $C \leq 10 \mu\text{F}$, rated voltage ≤ 6.3 V, measuring at voltage $0.5 V_{\text{rms}}$ at 20 °C $f = 120$ Hz for $C > 10 \mu\text{F}$, measuring at voltage $0.5 V_{\text{rms}}$ at 20 °C	In accordance with specification
Insulation Resistance	4.5.3	At U_r (DC) for 1 minute	In accordance with specification

NOTE:

1. For individual product specification, please contact local sales.

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS												
Temperature Characteristic	IEC 60384- 21/22 4.6	Capacitance shall be measured by the steps shown in the following table. The capacitance change should be measured after 5 min at each specified temperature stage. <table><tr><td>Step</td><td>Temperature(°C)</td></tr><tr><td>a</td><td>25±2</td></tr><tr><td>b</td><td>Lower temperature±3°C</td></tr><tr><td>c</td><td>25±2</td></tr><tr><td>d</td><td>Upper Temperature±2°C</td></tr><tr><td>e</td><td>25±2</td></tr></table> (1) Class I Temperature Coefficient shall be calculated from the formula as below $\text{Temp, Coefficient} = \frac{C2 - C1}{C1 \times \Delta T} \times 10^6 \text{ [ppm/°C]}$ C1: Capacitance at step c C2: Capacitance at 125°C ΔT: 100°C(=125°C-25°C) (2) Class II Capacitance Change shall be calculated from the formula as below $\Delta C = \frac{C2 - C1}{C1} \times 100\%$ C1: Capacitance at step c C2: Capacitance at step b or d	Step	Temperature(°C)	a	25±2	b	Lower temperature±3°C	c	25±2	d	Upper Temperature±2°C	e	25±2	<General purpose series> Class1: Δ C/C: ±30ppm Class2: X7R: Δ C/C: ±15% Y5V: Δ C/C: 22~-82% <High Capacitance series> Class2: X7R/X5R: Δ C/C: ±15% Y5V: Δ C/C: 22~-82%
Step	Temperature(°C)														
a	25±2														
b	Lower temperature±3°C														
c	25±2														
d	Upper Temperature±2°C														
e	25±2														
Adhesion	4.7	A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate	Force size ≥ 0603: 5N size = 0402: 2.5N size = 0201: 1N												

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS																																		
Bond Strength	4.8	Mounting in accordance with IEC 60384-22 paragraph 4.3	No visible damage																																		
		Conditions: bending 1 mm at a rate of 1 mm/s, radius jig 5 mm	$\Delta C/C$ Class2: X7R: $\pm 10\%$																																		
Resistance to Soldering Heat	4.9	Test Substrate:																																			
		 unit:mm	<table><tr><th></th><th colspan="3">Dimension(mm)</th></tr><tr><th>Type</th><th>a</th><th>b</th><th>c</th></tr><tr><td>0201</td><td>0.3</td><td>0.9</td><td>0.3</td></tr><tr><td>0402</td><td>0.4</td><td>1.5</td><td>0.5</td></tr><tr><td>0603</td><td>1.0</td><td>3.0</td><td>1.2</td></tr><tr><td>0805</td><td>1.2</td><td>4.0</td><td>1.65</td></tr><tr><td>1206</td><td>2.2</td><td>5.0</td><td>1.65</td></tr><tr><td>1210</td><td>2.2</td><td>5.0</td><td>2.0</td></tr><tr><td>1808</td><td>3.5</td><td>7.0</td><td>3.7</td></tr></table>		Dimension(mm)			Type	a	b	c	0201	0.3	0.9	0.3	0402	0.4	1.5	0.5	0603	1.0	3.0	1.2	0805	1.2	4.0	1.65	1206	2.2	5.0	1.65	1210	2.2	5.0	2.0	1808	3.5
	Dimension(mm)																																				
Type	a	b	c																																		
0201	0.3	0.9	0.3																																		
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0805	1.2	4.0	1.65																																		
1206	2.2	5.0	1.65																																		
1210	2.2	5.0	2.0																																		
1808	3.5	7.0	3.7																																		
Resistance to Soldering Heat	4.9	Precondition: 150 $\pm 0/-10$ $^{\circ}\text{C}$ for 1 hour, then keep for 24 ± 1 hours at room temperature Preheating: for size ≤ 1206 : 120 $^{\circ}\text{C}$ to 150 $^{\circ}\text{C}$ for 1 minute Preheating: for size > 1206 : 100 $^{\circ}\text{C}$ to 120 $^{\circ}\text{C}$ for 1 minute and 170 $^{\circ}\text{C}$ to 200 $^{\circ}\text{C}$ for 1 minute Solder bath temperature: 260 ± 5 $^{\circ}\text{C}$ Dipping time: 10 ± 0.5 seconds Recovery time: 24 ± 2 hours	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned																																		
			$\Delta C/C$ Class2: X7R: $\pm 10\%$																																		
Resistance to Soldering Heat	4.9		D.F. within initial specified value R_{ins} within initial specified value																																		

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability	IEC 60384-21/22	4.10 Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds. Test conditions for lead containing solder alloy Temperature: 235 ±5 °C Dipping time: 2 ±0.2 seconds Depth of immersion: 10 mm Alloy Composition: 60/40 Sn/Pb Number of immersions: 1 Test conditions for lead-free containing solder alloy Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm Alloy Composition: SAC305 Number of immersions: 1	The solder should cover over 95% of the critical area of each termination
Rapid Change of Temperature	4.11	Preconditioning: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature 5 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours	No visual damage $\Delta C/C$ Class2: X7R: ±15% D.F. meet initial specified value R_{ins} meet initial specified value

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Damp Heat with U_r Load	IEC 60384-21/22 4.13	1. Preconditioning, class 2 only: 150 $\pm$ 0/-10 $^{\circ}$C /1 hour, then keep for 24 $\pm$ 1 hour at room temp 2. Initial measure: Spec: refer to initial spec C, D, IR 3. Damp heat test: 500 $\pm$ 12 hours at 40 $\pm$ 2 $^{\circ}$C; 90 to 95% R.H. 1.0 U_r applied 4. Recovery: Class 2: 24 $\pm$ 2 hours 5. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met.	No visual damage after recovery <General Purpose series> $\Delta C/C$ Class2: X7R: $\pm$15% D.F. Class2: X7R: $\leq$ 16V: $\leq$ 7% $\geq$ 25V: $\leq$ 5% R_{ins} Class2: X7R: $\geq$ 500 MΩ or $R_{ins} \times C_r \geq$ 25s whichever is less <High Capacitance series($\geq$ 1uF) and CC0402xRX7R9BB104> $\Delta C/C$ Class2: X7R: $\pm$20% D.F. Class2: X7R: 2 $\times$ initial value max R_{ins} Class2: X7R: 500 MΩ or $R_{ins} \times C_r \geq$ 5s whichever is less

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Endurance	IEC 60384-21/22 4.14	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 2. Initial measure: Spec: refer to initial spec C, D, IR 3. Endurance test: Temperature: X7R: 125 °C Specified stress voltage applied for 1,000 hours: Applied 2.0 × U_r for general products* Applied 1.5 × U_r for high cap. Products* 4. Recovery time: 24 ±2 hours 5. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met. * General product: 0201 ≤ 10nF, 0402 ≤ 100nF, 0603 ≤ 470nF, 0805, 1206, 1210 ≤ 1uF; * High cap product: 0201 > 10nF, 0402 > 100nF, 0603 > 470nF, 0805, 1206, 1210 > 1uF;	No visual damage <General Purpose series> ΔC/C Class2: X7R: ±15% D.F. Class2: X7R: ≤ 16V: ≤ 7% ≥ 25V: ≤ 5% R_{ins} Class2: X7R: ≥ 1,000 MΩ or R_{ins} × C_r ≥ 50s whichever is less <High Capacitance series> ΔC/C Class 2: X7R: ±20% D.F. Class 2: X7R: 2 × initial value max R_{ins} Class 2: X7R: 1,000 MΩ or R_{ins} × C_r ≥ 10s whichever is less
Voltage Proof	IEC 60384-1 4.6	Specified stress voltage applied for 1~5 seconds U_r ≤ 100 V: series applied 2.5 U_r Charge/Discharge current is less than 50 mA	No breakdown or flashover

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 16	Dec 7th, 2016	-	- Dimension updated
Version 15	Oct. 3rd, 2016	-	- Dimension updated, Soldering recommendation updated
Version 14	May 31st, 2016	-	- Dimension updated
Version 13	Dec. 30, 2015	-	- Dimension on 0603 and 1206 case size updated
Version 12	May 26, 2015	-	- 1210, 25V dissipation factor updated
Version 11	Jan. 06, 2015	-	- 0402, 100nF, 50V Dissipation factor (D.F.) updated.
Version 10	Jul. 08, 2014	-	- Dimension updated
Version 9	Aug. 19, 2013	-	- Dimension updated
Version 8	Oct 13, 2011	-	- Dimension updated - 50V Dissipation factor(D.F) updated
Version 7	Jan 13, 2011	-	- Dimension updated
Version 6	Oct 13, 2010	-	- Rated voltage of 0201 extend to 50 V - Capacitance range of 0201 X7R 6.3V to 16V extend to 100 pF - Capacitance range of 0805 X7R 10V extend to 10 μ F - Capacitance range of 0805 X7R 50V extend to 1 μ F - Capacitance range of 1210 X7R 10V extend to 22 μ F - Figures of impedance ESR updated
Version 5	Jul 27, 2010	-	- Dimension on 0603 and 1206 case size updated - 16V to 25V Dissipation factor(D.F) updated
Version 4	Apr 21, 2010	-	- The statement of "Halogen Free" on the cover added - Dimension updated
Version 3	Oct 26, 2009	-	- Capacitance range of 0402 X7R 25 V extend to 100 nF - 16V Dissipation factor updated
Version 2	May 11, 2009	-	- Product range updated
Version 1	Apr 24, 2009	-	- Ordering code updated
Version 0	Apr 15, 2009	-	- New datasheet for general purpose and high capacitance X7R series with RoHS compliant - Replace the "6.3V to 50V" part of pdf files: X7R_10V_9, X7R_16V-to-100V_9, X7R_16-to-500V_9, UP-X5R_X7R_HighCaps_6.3-to-25V_11, UY-X5R_X7R_HighCaps_6.3-to-25V_11 - Combine 0201 from pdf files: UP-NP0X5RX7RY5V_0201_6.3-to-50V_2 and UY-NP0X5RX7RY5V_0201_6.3-to-50V_2 - Define global part number - Description of "Halogen Free compliant" added - Test method and procedure updated